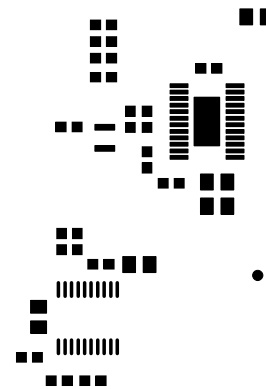
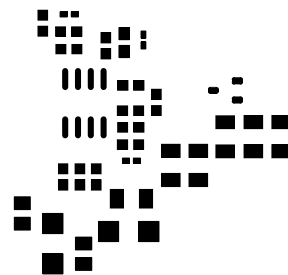
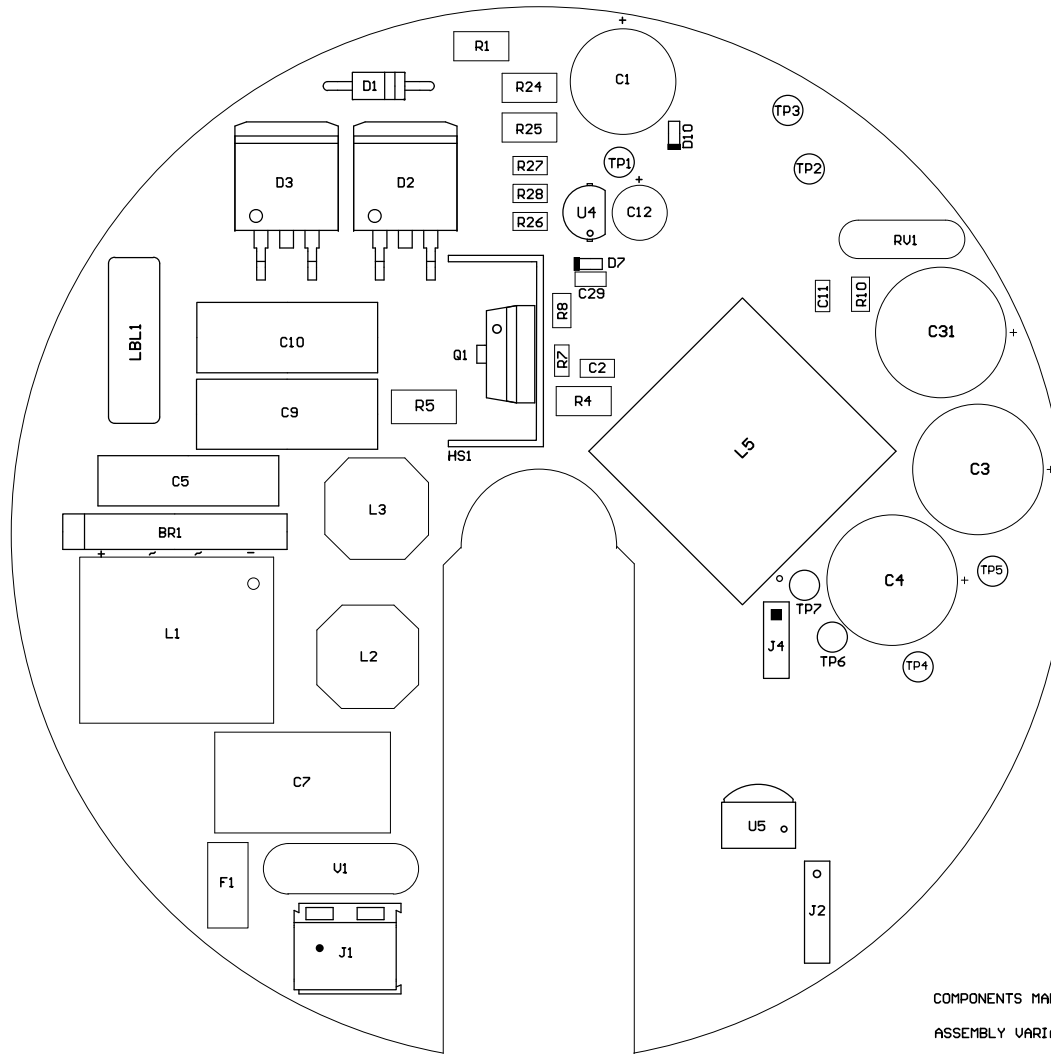


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Paste			
PLOT NAME = TIDA-00652.GTP	GENERATED : 9/23/2015 12:16:27 PM	TEXAS INSTRUMENTS	

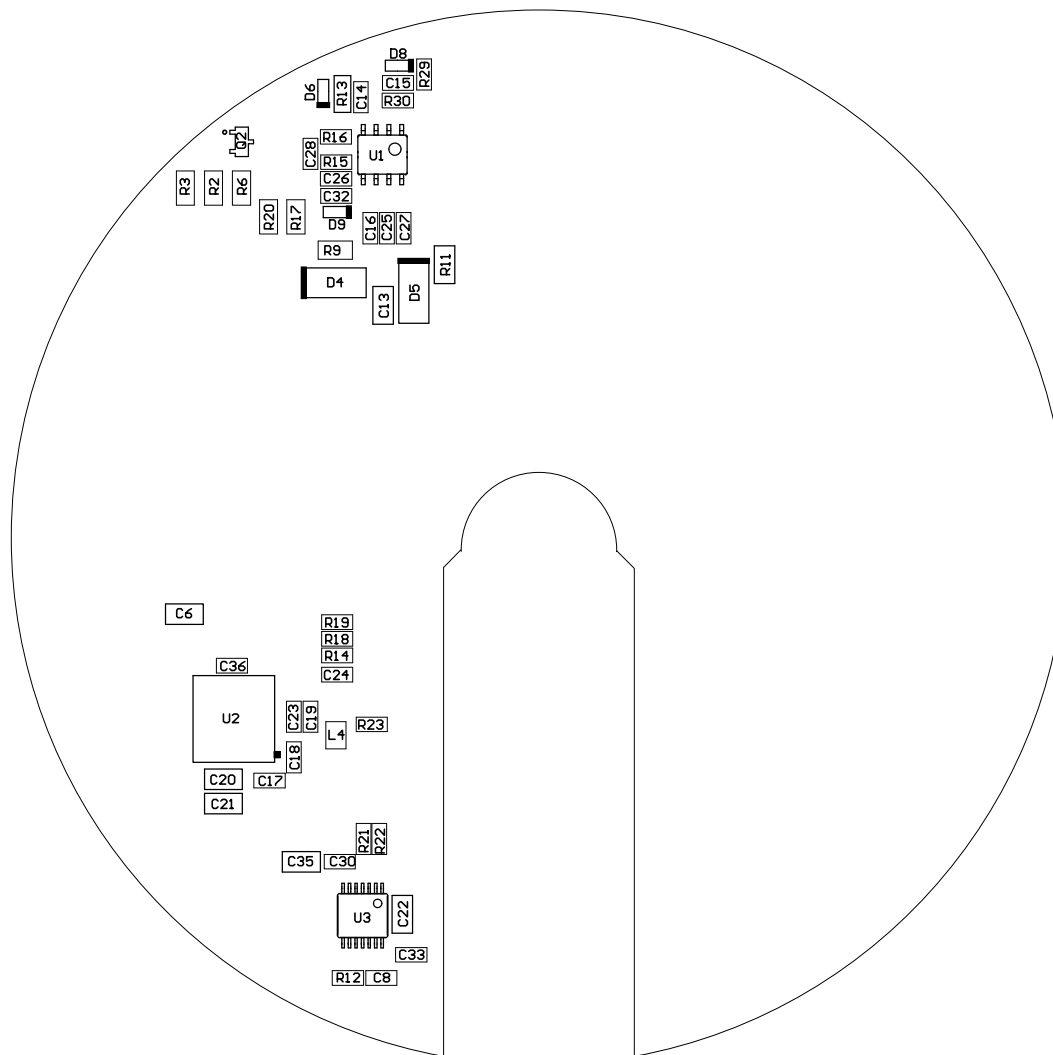


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste			
PLOT NAME = TIDA-00652.GBP	GENERATED : 9/23/2015 12:16:27 PM	TEXAS INSTRUMENTS	

- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



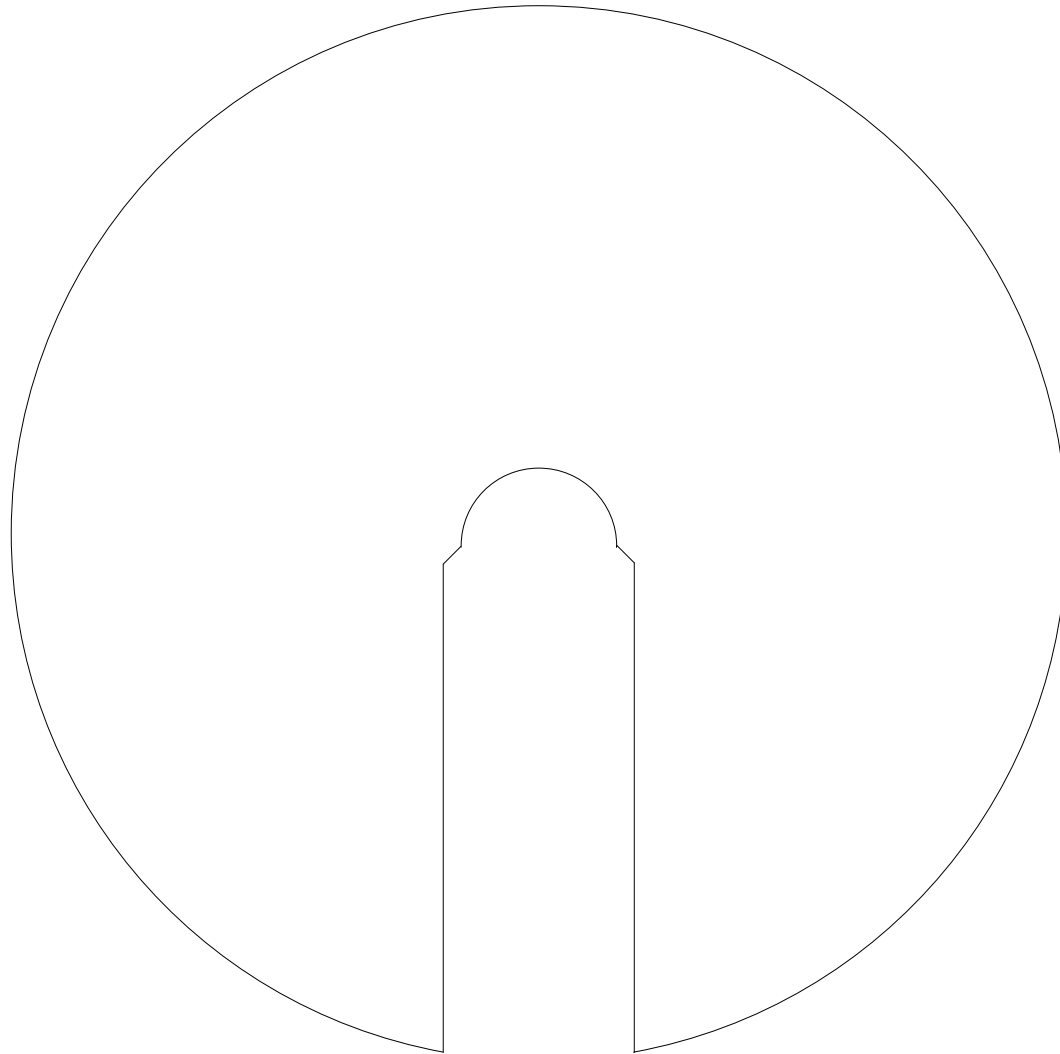
PCB VIEWED FROM TOP SIDE	BOARD #:	TIDA-00652	REV:	E2	SUN REV:	Not In VersionControl
Layer Name: Assembly Top						
PLOT NAME =	TIDA-00652.GM5	GENERATED :	9/23/2015	2:38:52 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00652	REV: E2	SUN REV: Not In VersionControl
Layer Name: Assembly Bottom			
PLOT NAME = TIDA-00652.GM6	GENERATED : 9/23/2015 2:38:52 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = TIDA-00652.GM1	GENERATED : 9/23/2015 12:16:27 PM	TEXAS INSTRUMENTS	

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